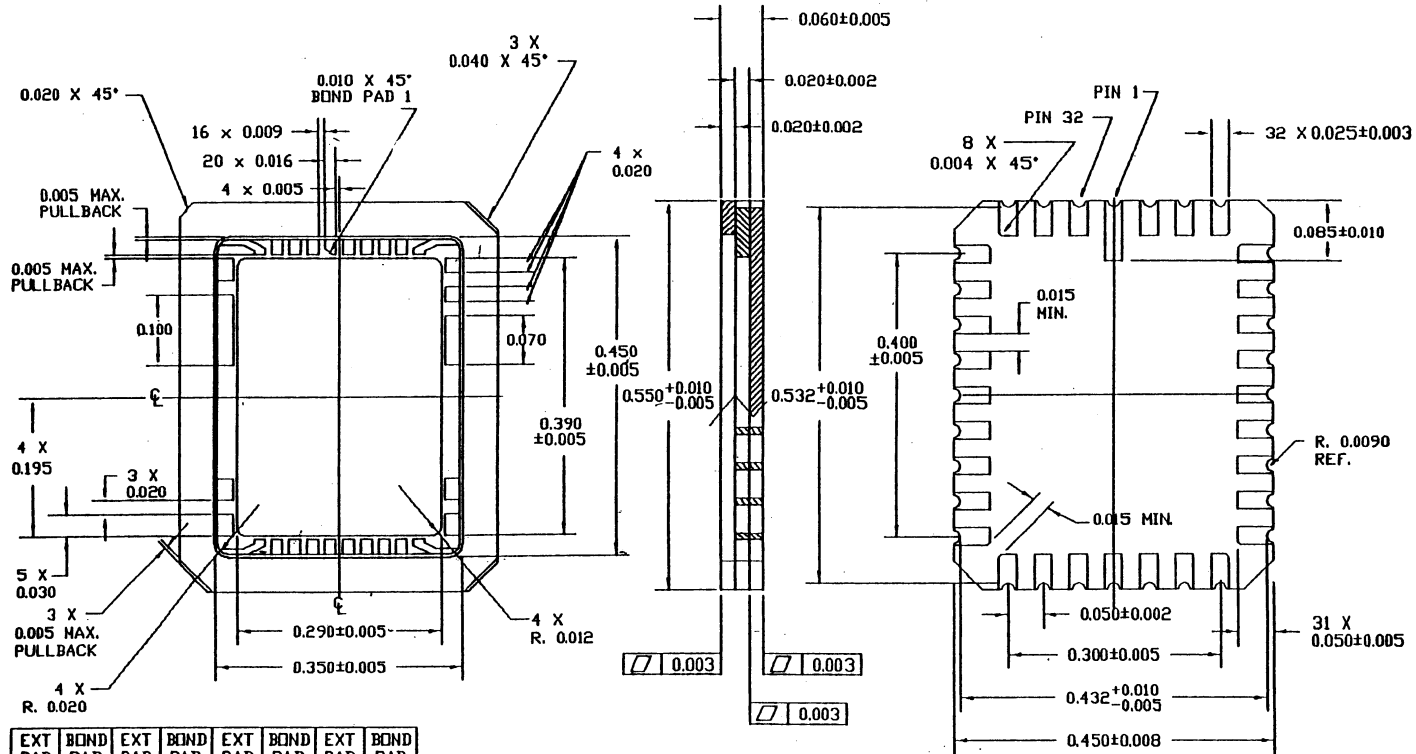


# SSM P/N LCC03249

**NOTES:**

1. INTERPRET DRAWING PER BOB-STD-104.
2. DIMENSIONS ARE TYPICAL FOR ALL DIMENSIONS UNLESS OTHERWISE SPECIFIED.
3. FINISH: GOLD PLATE 60µ INCHES MIN OVER 80µ INCHES MIN MINOR.
4. THE ATTACH CAVITY AND SEAL RINGS WILL BE ELECTRICALLY ISOLATED.
5. LEAD RESISTANCE: 400 mΩ MAX.
6. NO METAL IN S/A CAVITY.
7. ALL PARTS SHALL CONFORM TO SPEC. 683-08627 AND MIL-STD-883C.
8. PARTS SHALL COMPLY TO CPGA CONFIGURATION ON MIL-STD-1835.

REVISIONS					
ZONE	REV	ENH	DESCRIPTION	DATE	APPROVED
	MR	612	REV RELEASE	11/04/93	
	WA	700	CHG. NOTE #5	03/14/94	



EXT PAD	BOND PAD	EXT PAD	BOND PAD	EXT PAD	BOND PAD	EXT PAD	BOND PAD
1	N/C	9	8	17	N/C	25	22
2	1	10	9	18	15	26	23
3	2	11	10	19	16	27	24
4	3	12	N/C	20	17	28	25
5	4	13	11	21	18	29	26
6	5	14	12	22	19	30	27
7	6	15	13	23	20	31	28
8	7	16	14	24	21	32	29

UNLESS OTHERWISE SPECIFIED		BY		DATE	
DESIGNED BY	HTM	DATE	12/11/94		
CHECKED BY	HTM	DATE	12/11/94		
APPROVED BY	HTM	DATE	12/11/94		
MATERIAL		SIZE	C	PART NO.	51-2024B
FINISH		SCALE	10X	REV	WA
SEE NOTE 3				TITLE: 32 LD LCC 290 X 390	
				PAGE NO. 1	
				SHEET 1 OF 1	

